Si9933CDY

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Vishay Siliconix

SO-8 Dual D_2 D_2 5 D1 6 D, 8 G1 S₁ Top View

PRODUCT SUMMARY					
V _{DS} (V)	-20				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.058				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V	0.094				
Q _g typ. (nC)	8				
I _D (A) ^{a, e}	-4				
Configuration	Dual				

FEATURES

Dual P-Channel 20 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % $\rm R_g$ and UIS tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

Gı

P-Channel

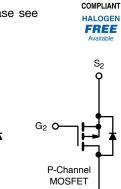
MOSFET

S₁

D₁

APPLICATIONS

- · Load switch
- DC/DC converter



RoHS

Ô D_2

ORDERING INFORMATION			
Package	SO-8		
Lead (Pb)-free	Si9933CDY-T1-E3		
Lead (Pb)-free and halogen-free	Si9933CDY-T1-GE3		

ABSOLUTE MAXIMUM RATINGS (T _A = 25	5 °C, unless other	wise noted)			
PARAMETER		SYMBOL	LIMIT	IT UNIT	
Drain-source voltage		V _{DS}	-20	- V	
Gate-source voltage		V _{GS}	± 12	v	
	T _C = 25 °C		-4 ^e		
Continuous drain surrant (T 150 °C)	T _C = 70 °C		-4 e		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-4 ^{b, c, e}	Ì	
	T _A = 70 °C	1	-3.8 ^{b, c}	•	
Pulsed drain current (10 µs pulse width)	I _{DM}	-20	- A		
Source-drain current diode current	T _C = 25 °C		-2.5		
	T _A = 25 °C	I _S	-1.7 ^{b, c}		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-6		
Single-pulse avalanche energy		E _{AS}	1.8	mJ	
	T _C = 25 °C		3.1		
Maximum power dissinction	T _C = 70 °C	P	2	w	
Maximum power dissipation	T _A = 25 °C	P _D	2 ^{b, c}	vv	
	T _A = 70 °C		1.28 ^{b, c}	7	
Operating junction and storage temperature range		T _J , T _{stq}	-50 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT		UNIT	
		STNIBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 10 s	R _{thJA}	52	62.5	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	32	40	C/W	

Notes

a. Based on $T_C = 25 \ ^\circ C$ b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 110 °C/W

e. Package limited

S-81729-Rev. A, 04-Aug-08

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.A	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050	-	-19	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	3.1	-	mV/°C	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.6	-	-1.4	V	
Gate-body leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	-	-	-100	nA	
7		$V_{DS} = -20 V, V_{GS} = 0 V$	-	-	-1	— uA	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10		
On-state drain current ^b	I _{D(on)}	V_{DS} = \leq -5 V, V_{GS} = -10 V	-20	-	-	А	
D · · · · · · · · ·		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -4.8 \text{ A}$	-	0.048	0.058	Ω	
Drain-source on-state resistance b	R _{DS(on)}	V _{GS} = -2.5 V, I _D = -1 A	-	0.075	0.094		
Forward transconductance b	g _{fs}	V _{DS} = -10 V, I _D = -4.8 A	-	11	-	S	
Dynamic ^a							
Input capacitance	C _{iss}		-	665	-	pF	
Output capacitance	C _{oss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	-	140	-		
Reverse transfer capacitance	C _{rss}		-	115	-		
		$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -4.8 \text{ A}$	-	17	26		
Total gate charge	Qg		-	8	12	nC	
Gate-source charge	Q _{qs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_{D} = -4.8 A	-	2	-		
Gate-drain charge	Q _{gd}		-	3	-		
Gate resistance	R _q	f = 1 MHz	1.2	6	12	Ω	
Turn-on delay time	t _{d(on)}		-	6	12		
Rise time	tr	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{I}} = 2.6 \Omega$	-	15	23		
Turn-off delay time	t _{d(off)}	$I_D \cong -3.8$ A, $V_{GEN} = -10$ V, $R_g = 1$ Ω	-	26	39		
Fall time	t _f		-	9	18		
Turn-on delay time	t _{d(on)}		-	21	32	ns	
Rise time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{L} = 2.6 \Omega$	-	50	75		
Turn-off delay time	t _{d(off)}	$I_D\cong$ -3.8 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	29	44		
Fall time	t _f		-	13	20		
Drain-Source Body Diode Characteris	tics						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-2.5		
Pulse diode forward current ^a	I _{SM}		-	-	-20	A	
Body diode voltage	V _{SD}	I _S = -3.8 A	-	-0.77	-1.2	V	
Body diode reverse recovery time	t _{rr}	-	-	30	45	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -3.8 A, di/dt = 100 A/μs,	-	17	26	nC	
Reverse recovery fall time	t _a	T _J = 25 °C		16	-		
	-a			14		ns	

Notes

a. Guaranteed by design, not subject to production testing

b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

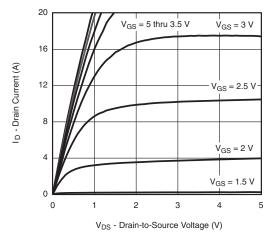
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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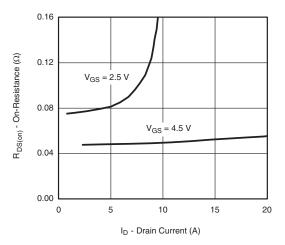
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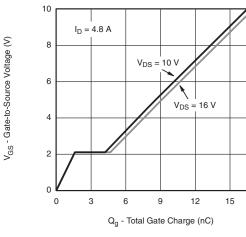
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



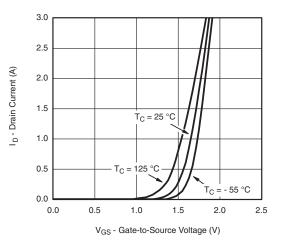
Output Characteristics



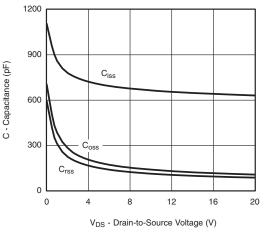
On-Resistance vs. Drain Current and Gate Voltage



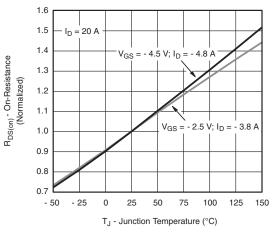
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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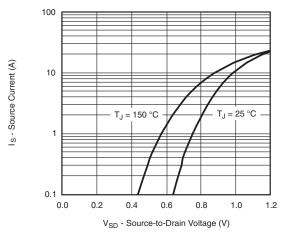
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Document Number: 68791

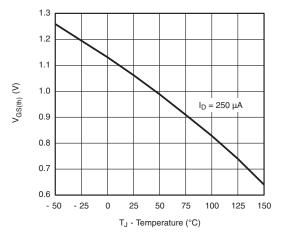
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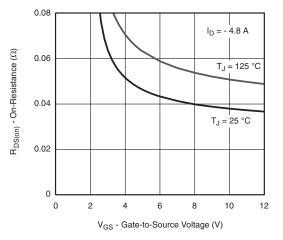
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



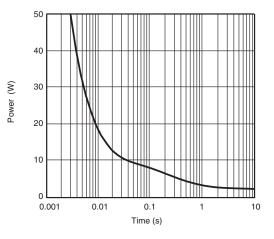
Source-Drain Diode Forward Voltage



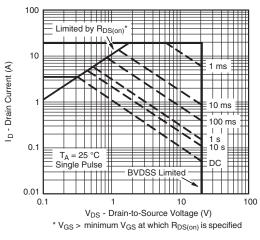




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



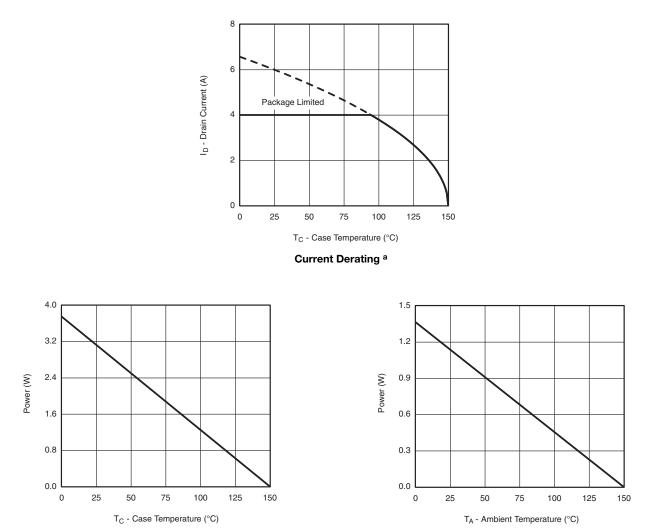
Safe Operating Area, Junction-to-Ambient

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

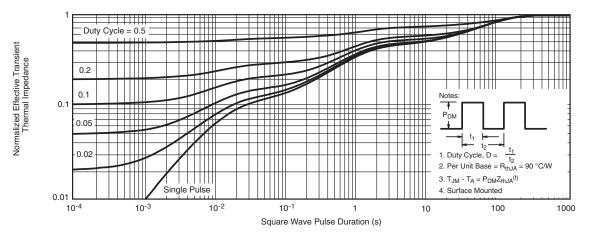
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

Power Derating, Junction-to-Foot

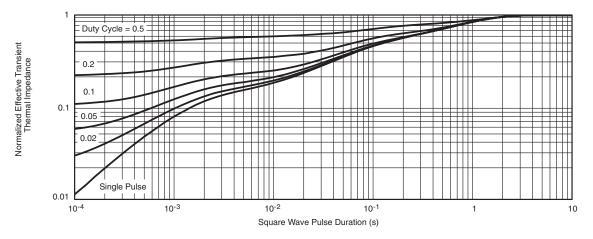
Power Derating, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?68791</u>.

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Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES		
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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